®
Integrated Device Technology, Inc.

FAST CMOS
1-OF-8 DECODER
WITH ENABLE

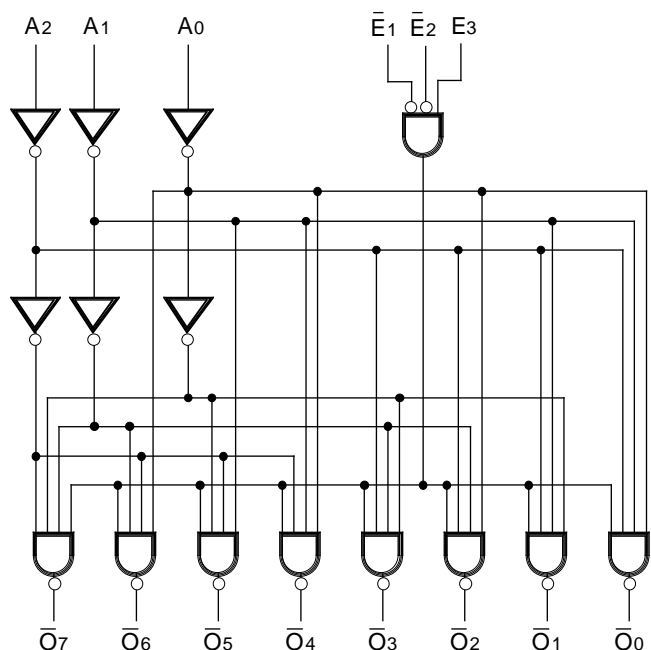**IDT54/74FCT138**
IDT54/74FCT138A
IDT54/74FCT138C

FEATURES:
- IDT54/74FCT138 equivalent to FAST™ speed
- **IDT54/74FCT138A 35% faster than FAST**
- **IDT54/74FCT138C 40% faster than FAST**
- Equivalent to FAST speeds output drive over full temperature and voltage supply extremes
- I_{OL} = 48mA (commercial) and 32mA (military)
- CMOS power levels (1mW typ. static)
- TTL input and output level compatible
- CMOS output level compatible
- Substantially lower input current levels than FAST (5µA max.)
- JEDEC standard pinout for DIP and LCC
- Product available in Radiation Tolerant and Radiation Enhanced versions
- Military product compliant to MIL-STD-883, Class B
- Standard Military Drawing # 5962-87654 is listed on this function. Refer to section 2.

DESCRIPTION:
The IDT54/74FCT138/A/C are 1-of-8 decoders built using an advanced dual metal CMOS technology. The IDT54/74FCT138/A/C accept three binary weighted inputs (A_0, A_1, A_2) and, when enabled, provide eight mutually exclusive active LOW outputs ($\overline{O}_0$ - $\overline{O}_7$). The IDT54/74FCT138/A/C feature three enable inputs, two active LOW ($\overline{E}_1$, $\overline{E}_2$) and one active HIGH (E_3). All outputs will be HIGH unless $\overline{E}_1$ and $\overline{E}_2$ are LOW and E_3 is HIGH. This multiple enable function allows easy parallel expansion of the device to a 1-of-32 (5 lines to 32 lines) decoder with just four IDT54/74FCT138/A/C devices and one inverter.

FUNCTIONAL BLOCK DIAGRAM

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PIN CONFIGURATIONS
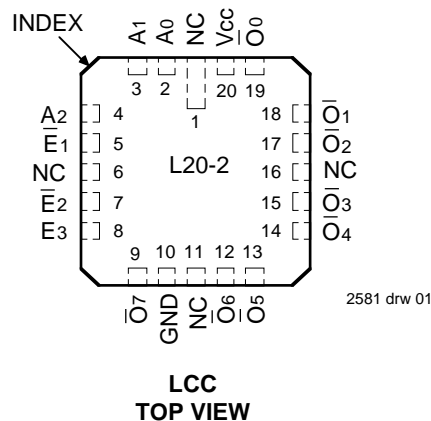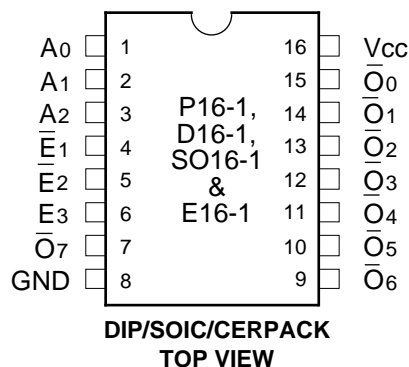
DIP/SOIC/CERPACK
TOP VIEW

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LCC
TOP VIEW

MILITARY AND COMMERCIAL TEMPERATURE RANGES

MAY 1992

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DSC-4625/3
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PIN DESCRIPTION

Pin Names	Description
A_0–A_2	Address Inputs
$\overline{E}_1$, $\overline{E}_2$	Enable Inputs (Active LOW)
E_3	Enable Input (Active HIGH)
$\overline{O}_0$–$\overline{O}_7$	Outputs (Active LOW)

2581 tbl 05

FUNCTION TABLE

Inputs						Outputs							
$\overline{E}_1$	$\overline{E}_2$	E_3	A_0	A_1	A_2	$\overline{O}_0$	$\overline{O}_1$	$\overline{O}_2$	$\overline{O}_3$	$\overline{O}_4$	$\overline{O}_5$	$\overline{O}_6$	$\overline{O}_7$
H	X	X	X	X	X	H	H	H	H	H	H	H	H
X	H	X	X	X	X	H	H	H	H	H	H	H	H
X	X	L	X	X	X	H	H	H	H	H	H	H	H
L	L	H	L	L	L	L	H	H	H	H	H	H	H
L	L	H	H	L	L	H	L	H	H	H	H	H	H
L	L	H	L	H	L	H	H	L	H	H	H	H	H
L	L	H	H	H	L	H	H	H	L	H	H	H	H
L	L	H	L	L	H	H	H	H	H	L	H	H	H
L	L	H	H	L	H	H	H	H	H	H	L	H	H
L	L	H	L	H	H	H	H	H	H	H	H	L	H
L	L	H	H	H	H	H	H	H	H	H	H	H	L

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ABSOLUTE MAXIMUM RATINGS[1]

Symbol	Rating	Commercial	Military	Unit
V_{TERM}[2]	Terminal Voltage with Respect to GND	–0.5 to +7.0	–0.5 to +7.0	V
V_{TERM}[3]	Terminal Voltage with Respect to GND	–0.5 to V_{CC}	–0.5 to V_{CC}	V
T_A	Operating Temperature	0 to +70	–55 to +125	°C
T_{BIAS}	Temperature Under Bias	–55 to +125	–65 to +135	°C
T_{STG}	Storage Temperature	–55 to +125	–65 to +150	°C
P_T	Power Dissipation	0.5	0.5	W
I_{OUT}	DC Output Current	120	120	mA

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NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability. No terminal voltage may exceed V_{CC} by +0.5V unless otherwise noted.
2. Inputs and V_{CC} terminals only.
3. Outputs and I/O terminals only.

CAPACITANCE (T_A = +25°C, f = 1.0MHz)

Symbol	Parameter[1]	Conditions	Typ.	Max.	Unit
C_{IN}	Input Capacitance	V_{IN} = 0V	6	10	pF
C_{OUT}	Output Capacitance	V_{OUT} = 0V	8	12	pF

NOTE: 2581 tbl 02

1. This parameter is guaranteed characterization data and not tested.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: V_{LC} = 0.2V; V_{HC} = V_{CC} – 0.2V

Commercial: T_A = 0°C to +70°C, V_{CC} = 5.0V ± 5%; Military: T_A = –55°C to +125°C, V_{CC} = 5.0V ± 10%

Symbol	Parameter	Test Conditions[1]		Min.	Typ.[2]	Max.	Unit
V_{IH}	Input HIGH Level	Guaranteed Logic HIGH Level		2.0	—	—	V
V_{IL}	Input LOW Level	Guaranteed Logic LOW Level		—	—	0.8	V
I_{IH}	Input HIGH Current	V_{CC} = Max.	V_I = V_{CC}	—	—	5	µA
			V_I= 2.7V	—	—	5[4]	
I_{IL}	Input LOW Current		V_I= 0.5V	—	—	–5[4]	
			V_I = GND	—	—	–5	
V_{IK}	Clamp Diode Voltage	V_{CC} = Min., I_N = –18mA		—	–0.7	–1.2	V
I_{OS}	Short Circuit Current	V_{CC} = Max.[3], V_O = GND		–60	–120	—	mA
V_{OH}	Output HIGH Voltage	V_{CC} = 3V, V_{IN} = V_{LC} or V_{HC}, I_{OH} = –32µA		V_{HC}	V_{CC}	—	V
		V_{CC} = Min.	I_{OH} = –300µA	V_{HC}	V_{CC}	—	
		V_{IN} = V_{IH} or V_{IL}	I_{OH} = –12mA MIL.	2.4	4.3	—	
			I_{OH} = –15mA COM'L.	2.4	4.3	—	
V_{OL}	Output LOW Voltage	V_{CC} = 3V, V_{IN} = V_{LC} or V_{HC}, I_{OL} = 300µA		—	GND	V_{LC}	V
		V_{CC} = Min.	I_{OL} = 300µA	—	GND	V_{LC}[4]	
		V_{IN} = V_{IH} or V_{IL}	I_{OL} = 32mA MIL.	—	0.3	0.5	
			I_{OL} = 48mA COM'L.	—	0.3	0.5	

NOTES:
2581 tbl 03
1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at V_{CC} = 5.0V, +25°C ambient and maximum loading.
3. Not more than one output should be shorted at one time. Duration of the short circuit test should not exceed one second.
4. This parameter is guaranteed but not tested.

POWER SUPPLY CHARACTERISTICS

V_{LC} = 0.2V; V_{HC} = V_{CC} – 0.2V

Symbol	Parameter	Test Conditions[1]		Min.	Typ.[2]	Max.	Unit
I_{CC}	Quiescent Power Supply Current	Vcc = Max. $V_{IN} \geq V_{HC}$; $V_{IN} \leq V_{LC}$		—	0.2	1.5	mA
ΔI_{CC}	Quiescent Power Supply Current TTL Inputs HIGH	Vcc = Max. V_{IN} = 3.4V[3]		—	0.5	2.0	mA
I_{CCD}	Dynamic Power Supply Current[4]	Vcc = Max. Outputs Open One Output Toggling 50% Duty Cycle	$V_{IN} \geq V_{HC}$ $V_{IN} \leq V_{LC}$	—	0.15	0.3	mA/MHz
I_C	Total Power Supply Current[5]	Vcc = Max. Outputs Open Toggle $\bar{E}_1$, $\bar{E}_2$ or E_3	$V_{IN} \geq V_{HC}$ $V_{IN} \leq V_{LC}$ (FCT)	—	1.7	4.5	mA
		50% Duty Cycle f_O = 10MHz One Output Toggling	V_{IN} = 3.4V V_{IN} = GND	—	2.0	5.5	

NOTES:
2581 tbl 04
1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at V_{CC} = 5.0V, +25°C ambient.
3. Per TTL driven input (V_{IN} = 3.4V); all other inputs at V_{CC} or GND.
4. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
5. $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$
   $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_{CP}/2 + f_O N_O)$
   I_{CC} = Quiescent Current
   ΔI_{CC} = Power Supply Current for a TTL High Input (V_{IN} = 3.4V)
   D_H = Duty Cycle for TTL Inputs High
   N_T = Number of TTL Inputs at D_H
   I_{CCD} = Dynamic Current Caused by an Output Transition Pair (HLH or LHL)
   f_{CP} = Clock Frequency for Register Devices (Zero for Non-Register Devices)
   f_O = Output Frequency
   N_O = Number of Outputs at f_O
   All currents are in milliamps and all frequencies are in megahertz.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Symbol	Parameter	Condition[1]	IDT54/74FCT138				IDT54/74FCT138A				IDT54/74FCT138C				Unit
			Com'l.		Mil.		Com'l.		Mil.		Com'l.		Mil.		
			Min.[2]	Max.	Min.[2]	Max.	Min.[2]	Max.	Min.[2]	Max.	Min.[2]	Max.	Min.[2]	Max.	
t_{PLH} t_{PHL}	Propagation Delay A_n to $\overline{O}_n$	$C_L = 50pF$ $R_L = 500\Omega$	1.5	9.0	1.5	12.0	1.5	5.8	1.5	7.8	1.5	5.1	1.5	6.0	ns
t_{PLH} t_{PHL}	Propagation Delay $\overline{E}_1$ or $\overline{E}_2$ to $\overline{O}_n$		1.5	9.0	1.5	12.5	1.5	5.9	1.5	8.0	1.5	5.2	1.5	6.1	ns
t_{PLH} t_{PHL}	Propagation Delay E_3 to $\overline{O}_n$		1.5	9.0	1.5	12.5	1.5	5.9	1.5	8.0	1.5	5.2	1.5	6.1	ns

2581 tbl 07

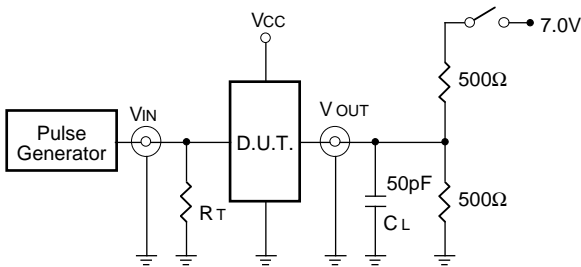**NOTES:**
1. See test circuit and waveforms.
2. Minimum limits are guaranteed but not tested on Propagation Delays.

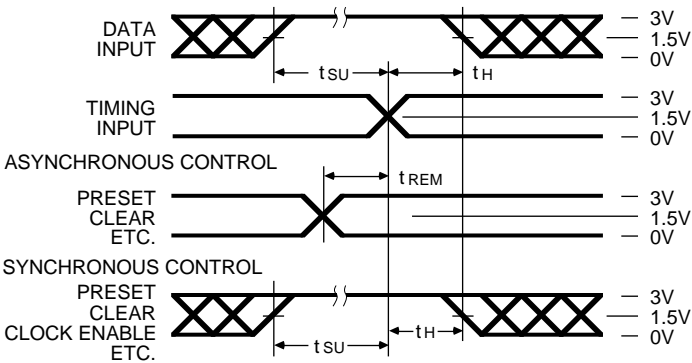# TEST CIRCUITS AND WAVEFORMS

TEST CIRCUITS FOR ALL OUTPUTS

SWITCH POSITION

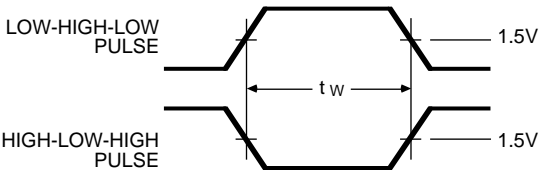| Test	Switch
Open Drain Disable Low Enable Low	Closed
All Other Test	Open

2581 tbl 08

DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.

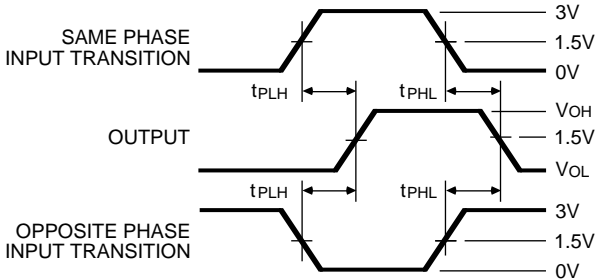R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

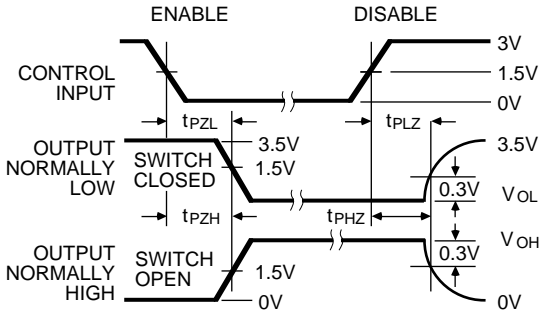## SET-UP, HOLD AND RELEASE TIMES

PULSE WIDTH

PROPAGATION DELAY

ENABLE AND DISABLE TIMES

NOTES

2581 drw 04

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
2. Pulse Generator for All Pulses: Rate $\leq$ 1.0 MHz; $Z_O \leq 50\Omega$; $t_F \leq 2.5$ns; $t_R \leq 2.5$ns.

ORDERING INFORMATION

```
IDT    XX    FCT    X      X      X
    Temperature   Device  Package  Process
      Range         Type
```

Blank	Commercial	
B	MIL-STD-883, Class B	

P	Plastic DIP
D	CERDIP
SO	Small Outline IC
E	CERPACK
L	Leadless Chip Carrier

138	1-of-8 Decoder
138A	Fast 1-of-8 Decoder
138C	Super Fast 1-of-8 Decoder

54	–55°C to +125°C
74	0°C to +70°C

2581 drw 03